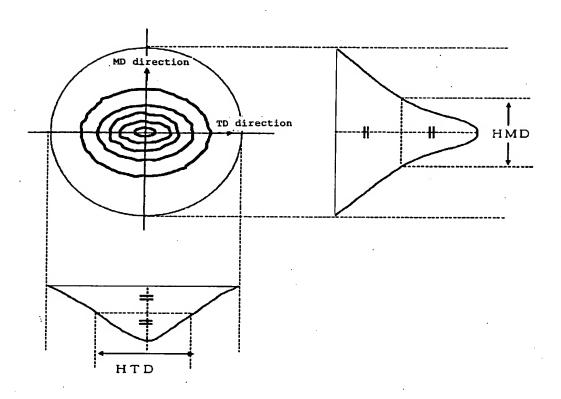
App No.: Not Yet Assigned Inventor: Masayuki TSUTSUMI et al. Title: POLYIMIDE FILM

FIG. 1

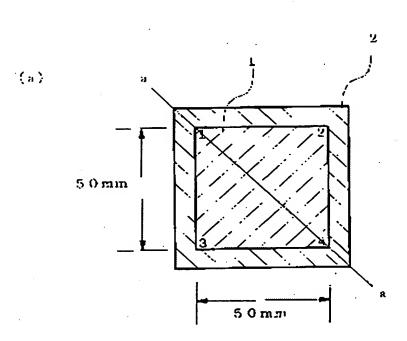
Docket No.: 358362011300

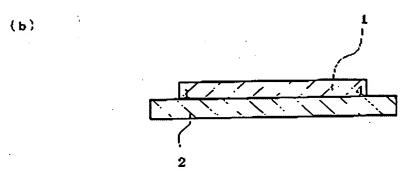


App No.: Not Yet Assigned Inventor: Masayuki TSUTSUMI et al. Title: POLYIMIDE FILM

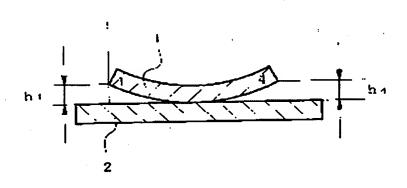
Docket No.: 358362011300

FIG. 2





(g)

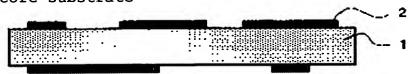


Docket No.: 358362011300 App No.: Not Yet Assigned

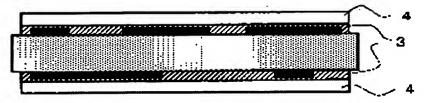
Inventor: Masayuki TSUTSUMI et al. Title: POLYIMIDE FILM

FIG. 3

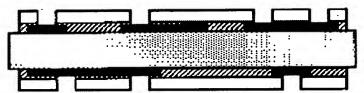
(a) core substrate



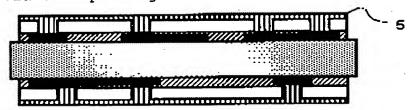
(b) first interlayer insulation layer formation



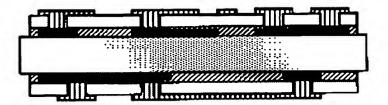
(c) via-hole perforation



(d) via fill plating



(e) first buildup layer pattern formation

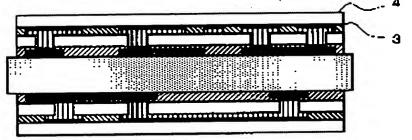


App No.: Not Yet Assigned Inventor: Masayuki TSUTSUMI et al. Title: POLYIMIDE FILM

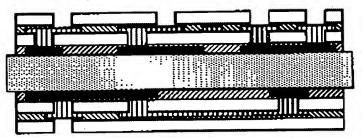
Docket No.: 358362011300

FIG. 4

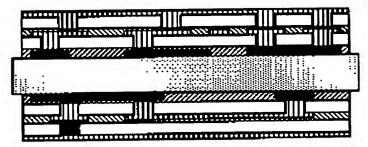
(e) second interlayer insulation layer formation



(b) via-hole perforation



(c) via fill plating



(d) second buildup layer pattern formation

